IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application Serial No	10/695,727
Filing Date	10/28/2003
Inventorship	
Assignee	Micron Technology, Inc.
Group Art Unit	1763
Examiner	Karla Moore
Customer No	
Attorney's Docket No	
Title: Semiconductor Substrate Processi	ng Chamber and Accessory Attachment
Interfacial Structure	

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT References - See Attached Form PTO-1449

The attached Form PTO-1449 is submitted in compliance with 37 CFR §1.56. Pursuant to FEDERAL REGISTER, Vol. 69, No. 182, pg. 56542 (September 21, 2004), no copies of any cited U.S. patents or U.S. published applications are included herewith. No admission is made regarding whether the listed references are prior art.

Respectfully submitted,

Dated: 5- (8-01

Mark S. Matkin Reg. No. 32,268

Form PTO-1448			U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE				ATTY, DOCKET NO. MI22-2433			SERIAL NO. 10/695,727		
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not considered. Include copy of this form with next communication to applicant.